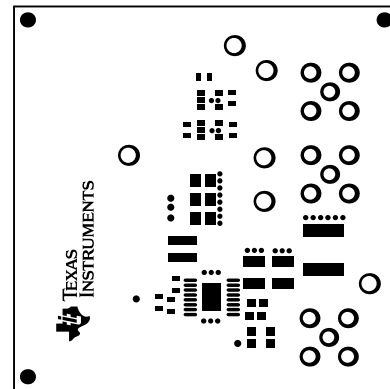
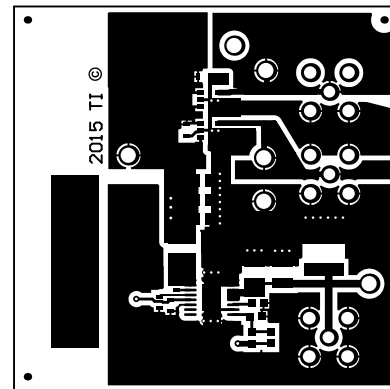


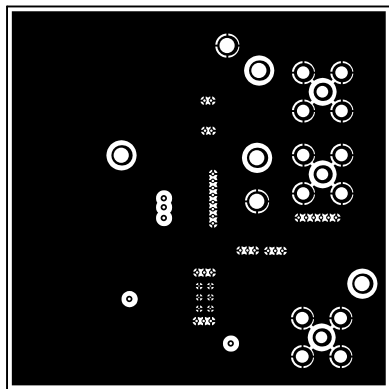
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00535	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: 00535		
PLOT NAME = Top Overlay	GENERATED : 7/21/2015 2:25:19 PM	TEXAS INSTRUMENTS	



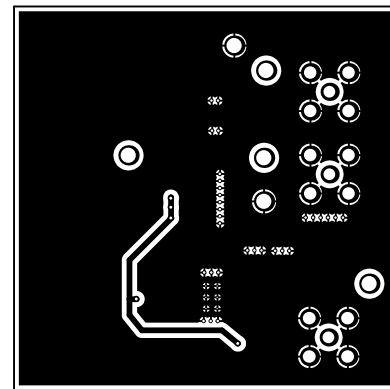
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00535	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: 00535		
PLOT NAME = Top Solder Mask	GENERATED : 7/21/2015 2:25:20 PM	TEXAS INSTRUMENTS	



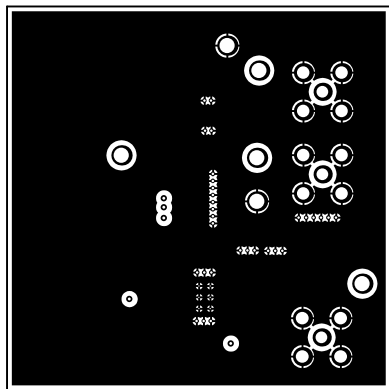
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00535	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: 00535		
PLOT NAME = Top Layer	GENERATED : 7/21/2015 2:25:21 PM	TEXAS INSTRUMENTS	



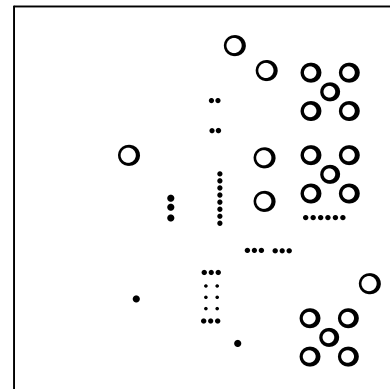
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00535	REV: E1	SUN REV: Not In VersionControl
LAYER NAME =	TID #: 00535		
PLOT NAME = Signal Layer 1	GENERATED : 7/21/2015 2:25:21 PM	TEXAS INSTRUMENTS	



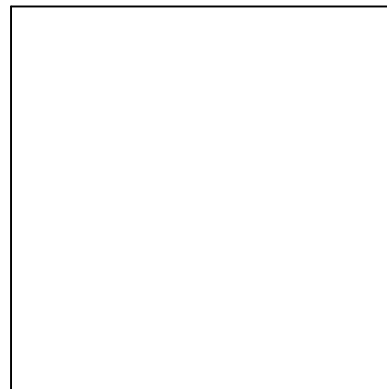
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00535	REV: E1	SUN REV: Not In VersionControl
LAYER NAME =	TID #: 00535		
PLOT NAME = Signal Layer 2	GENERATED : 7/21/2015 2:25:22 PM	TEXAS INSTRUMENTS	



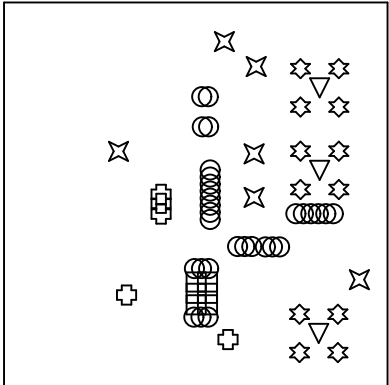
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00535	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: 00535		
PLOT NAME = Bottom Layer	GENERATED : 7/21/2015 2:25:23 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00535	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: 00535		
PLOT NAME = Bottom Solder Mask	GENERATED : 7/21/2015 2:25:23 PM	TEXAS INSTRUMENTS	

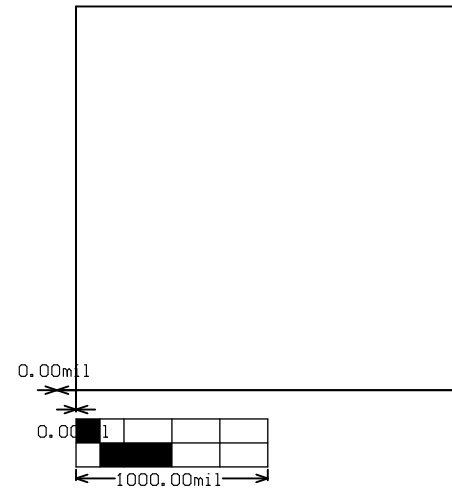


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00535	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: 00535		
PLOT NAME = Bottom Overlay	GENERATED : 7/21/2015 2:25:24 PM	TEXAS INSTRUMENTS	



Symbol	Quantity	Finished Hole Size	Plated	Hole Type
□	6	7.87mil (0.200mm)	PTH	Round
○	30	14.00mil (0.356mm)	PTH	Round
⊗	5	16.00mil (0.406mm)	PTH	Round
▽	3	62.00mil (1.575mm)	PTH	Round
☆	12	67.00mil (1.702mm)	PTH	Round
⊠	6	80.71mil (2.050mm)	PTH	Round
	62 Total			

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00535	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: 00535		
PLOT NAME = Drill Drawing	GENERATED : 7/21/2015	2:25:25 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00535	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: 00535		
PLOT NAME = Board Dimensions	GENERATED : 7/21/2015 2:25:25 PM	TEXAS INSTRUMENTS	

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